

STPS30U100DJF

ULVF[™] power Schottky rectifier

Features

- High current capability
- Ultralow forward voltage drop
- Low thermal resistance
- High frequency operation
- High integration

Description

The STPS30U100DJF is a power Schottky rectifier featuring an ultralow forward voltage drop (ULVF), suited for high frequency switch mode power supply and DC to DC converters.

Packaged in PowerFLAT[™], this device is intended to be used in notebook, game station and desktop adapters, providing these applications with good efficiency at both low and high load. Its low profile was especially designed to be used in applications with space-saving constraints.

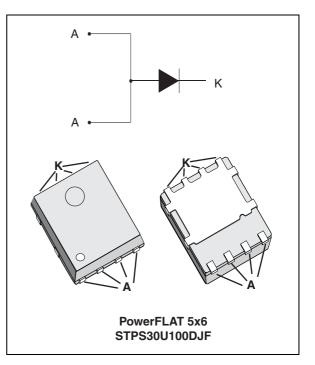


Table 1. Device summary

Symbol	Value
I _{F(AV)}	30 A
V _{RRM}	100 V
T _j (max)	150 °C
V _F (typ)	0.69 V

TM: ULVF and PowerFLAT are trademarks of STMicroelectronics

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1 Characteristics

Table 2. Absolute ratings (limiting values, anode terminals short circuited)

Symbol	Parameter	Value	Unit	
V _{RRM}	Repetitive peak reverse voltage	100	V	
I _{F(RMS)}	Forward rms current	45	А	
I _{F(AV)}	Average forward current $T_c = 75^{\circ}C, \ \delta = 0.5$		30	А
I _{FSM}	Surge non repetitive forward current t _p = 10 ms sine-wave		200	А
T _{stg}	Storage temperature range	-65 to + 150	°C	
Тj	Maximum operating junction temperatu	150	°C	

1. $\frac{dPtot}{dT_j} < \frac{1}{Rth(j-a)}$ condition to avoid thermal runaway for a diode on its own heatsink

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit
R _{th(j-c)}	Junction to case	2.5	°C/W

Table 4. Static electrical characteristics (anode terminals short circuited)

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
	IR ⁽¹⁾ Reverse leakage current	T _j = 125 °C	V _R = 70 V	-	8	-	mA
$I_{R}^{(1)}$		T _j = 25 °C	V _R = V _{RRM}	-	-	170	μΑ
		T _j = 125 °C		-	20	45	mA
V _F ⁽²⁾ F	Forward voltage drop	T _j = 125 °C	I _F = 5 A	-	0.38	0.42	
		T _j = 125 °C	I _F = 10 A	-	0.475	0.53	V
		T _j = 25 °C	I _F = 30 A	-	-	0.855	v
		$T_j = 125 \ ^\circ C$		-	0.69	0.77	

1. Pulse test: $t_p = 5 \text{ ms}, \delta < 2\%$

2. Pulse test: t_p = 380 µs, δ < 2%

To evaluate the maximum conduction losses use the following equation: P = 0.590 x $I_{F(AV)}$ + 0.006 x ${I_{F}}^2_{(RMS)}$



180 I_M(A)

160

140

120

100

80

60

40

20

0

1.E-03

Figure 1. Average forward power dissipation Figure 2. versus average forward current (maximum values)

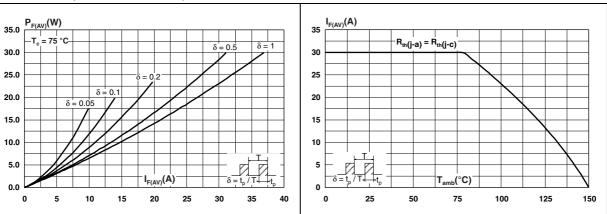


Figure 3. Non repetitive surge peak forward current versus overload duration (maximum values)

Figure 4. Relative variation of thermal impedance, junction to case, versus pulse duration

Average forward current versus

ambient temperature ($\delta = 0.5$)

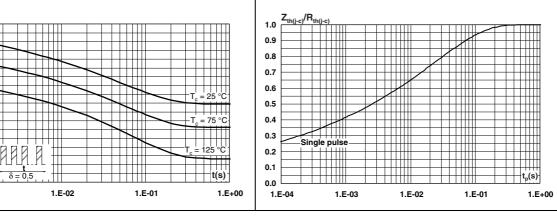
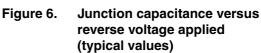


Figure 5. Reverse leakage current versus reverse voltage applied (typical values)



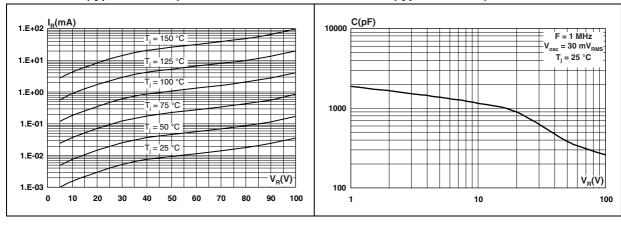
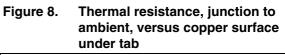
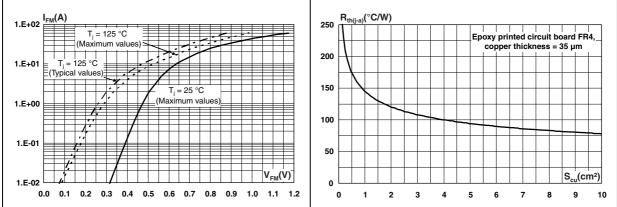




Figure 7. Forward voltage drop versus forward current







2 Application information

It is mandatory to ensure a peak reverse voltage below the $V_{\rm RRM}$ absolute rating. Therefore ST recommends the use of an RC clamping snubber circuit in parallel with the STPS30U100DJF device.

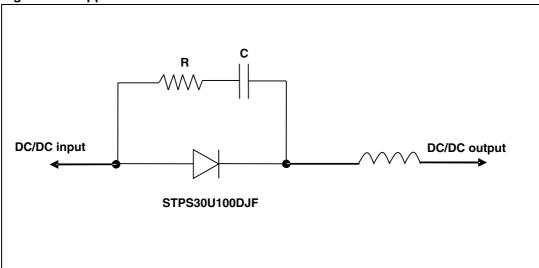


Figure 9. Application schematic



3 Package information

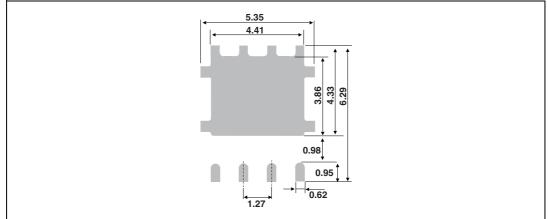
- Epoxy meets UL94,V0
- Lead-free package

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: <u>www.st.com</u>. ECOPACK[®] is an ST trademark.

Table 5.PowerFLAT 5x6 dimensions

		Dimensions					
للضحطا	Ref. Millimeters		Inches				
		Min.	Тур.	Max.	Min.	Тур.	Max.
	А	0.80		1.00	0.031		0.039
 ↓ κ	A1	0.02		0.05	0.001		0.002
	A2		0.25			0.010	
	b	0.30		0.50	0.012		0.020
$A1 \downarrow $	D		5.20			0.205	
	D2	4.11		4.31	0.162		0.170
	е		1.27			0.050	
E	Е		6.15			0.242	
	E2	3.50		3.70	0.138		0.146
	L	0.50		0.80	0.020		0.031
	К	1.275		1.575	0.050		0.062

Figure 10. Footprint (dimensions in mm)





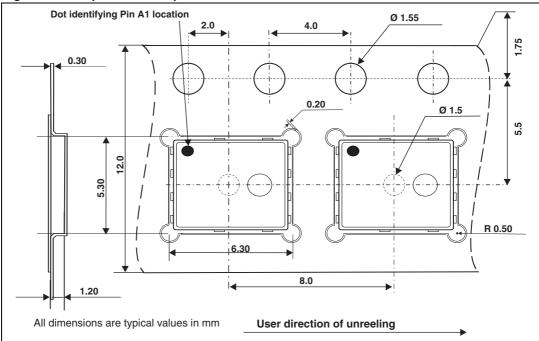


Figure 11. Tape and reel specifications

4 Ordering information

Table 6.	Ordering	information
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Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS30U100DJF-TR	PS30 U100	PowerFLAT 5x6	95 mg	3000	Tape and reel

5 Revision history

Table 7.Document revision history

Date	Revision	Changes
02-Nov-2010	1	First issue.
09-Dec-2010	2	Added "maximum" to conduction loss calculation in <i>Section 1 on page 2</i> .
20-May-2011	3	Added reference E in <i>Table 5</i> . Updated package graphics. Updated base quantity and marking in <i>Table 6</i> . Added <i>Figure 11</i> .



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